

TAIYO AMERICA, INC.
 2675 Antler Drive, Carson City, NV 89701
 Phone: (775) 885-9959 Fax: (775) 885-9972

CERTIFICATE OF ANALYSIS and CONFORMANCE

This is to certify that the following product has been inspected prior to sale and shipment, and complies with Taiyo America's manufacturing specifications for this product.

PSR-4000MP Red Lot # 0082037

Mfg. Date: 8-20-20
 Warranty Ends: 8-20-21

<u>PROPERTY</u>	<u>TEST METHOD</u>	<u>MANUFACTURING SPECIFICATION</u>	<u>RESULT</u>
VISCOSITY	Toki Sangyo RE100U Viscometer 5 rpms @ 25°C	Before mixing: 350 - 400 ps After mixing: 140 - 180 ps	362 ps 156 ps
THIXOTROPIC INDEX	Toki Sangyo RE100U Viscometer Viscosity ratio: 5 rpm / 50 rpm	After mixing: 1.2 - 1.6	1.5
FINENESS OF GRIND	TAI-0-0002	20 microns maximum	15 microns
VISUAL EXAMINATION	Microscopic examination: 1. 1-mil drawdown of wet film	No bubbles, pits, voids, particles, color differences.	Passed <input checked="" type="checkbox"/>
	2. Wet film drawdown on grind gauge	No bubbles, pits, voids, particles, color differences.	Passed <input checked="" type="checkbox"/>
SCREENABILITY	Visual inspection of screen printed panel	No surface defects, such as bubbles, pinholes, etc.	Passed <input checked="" type="checkbox"/>
TACK-DRY	Hot air convection oven 80°C / 30 minutes	Tack-free to the touch	Passed <input checked="" type="checkbox"/>
IMAGING	ORC HMW 680GW - 7 kW 300 mJ / cm ² (under artwork) Horizontal Developer - 1% Na ₂ CO ₃ 30°C (86°F) / 60 secs., 28 psi	Stouffer 21 step: 8 - 12 (clear on copper)	11
RESISTANCE TO SOLDERING (*)	260°C (500°F) / 10 sec x 3 cycles Rosin-based flux	No discoloration, peeling, or blistering	Passed <input checked="" type="checkbox"/>
SOLVENT RESISTANCE (*)	Immersion in PM Acetate 20°C / 30 mins.	No swelling, softening, or blistering	Passed <input checked="" type="checkbox"/>
PENCIL HARDNESS (*)	TAI-0-0020	7H or greater	9H
ADHESION (*)	TAI-0-0021	100/100 on copper	Passed <input checked="" type="checkbox"/>

(*) - Final cure for these tests was 60 minutes @ 150°C (302°F) in a convection oven

Verified By: *[Signature]* Title: Q.C. SUPERVISOR Date: 8/21/20